

BOSE CORPORATION · THE MOUNTAIN · FRAMINGHAM, MASS. 01701

SOLID STATE FOUR CHANNEL PREAMPLIFIER



SPECIFICATIONS

The 4401 preamplifier offers four independent channels from input to output with a capability of matrix decoding, discrete four-channel, or stereo operation. Signals from all current program sources, both stereo and quadraphonic, can be processed by the 4401.

The 4401 incorporates unique phono preamp circuitry, utilizing METTM (Minimum Effective Temperature) circuitry accounting for the ultra-quiet operation of the phono

Optional circuitry for the SQ decoder and the CD-4 demodulator is contained on easily-installed, plug-in modules. *

Internal provisions for an additional fourchannel module are provided for yet-to-bedeveloped four-channel systems.

The tone control circuits, as well as the high and low filters, can be used to process a signal prior to recording. Recordings can be made on two tape recorders simultaneously, and tapes can be copied from either tape recorder.

The 4401 provides separate jacks for the connection of external equalizers. A rear channel equalizer by-pass switch allows equalization of only the front channels without the use of jumper cables for the rear channels.

GENERAL

Separate left/right balance controls for both front and rear channels.

Independent front and rear channel tone controls.

Baxendall tone control circuits for optimum frequency contour control.

Output amplifiers capable of driving both low and high impedance headphones.

Time delay circuitry eliminating turn-on transients.

Two-position phono capacitance switch for optimum matching of conventional or CD-4 phono cartridges.

Optional SQ decoder and CD-4 demodulator plug-in modules.*

Optional remote balance/volume control.

ELECTRONIC

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Phono 1		 	 	. 2m	າv@1kHz
Phono 2		 	 	. 2n	w@1kHz
Tuner .	 	 	 		. 200mv
Aux	 	 	 		. 200mv
Tape 1	 	 	 		. 200mv
Tape 2	 	 	 		. 200mv

Rated Output:

2∨	RMS.					Minimum 7v RMS
						before overload.

Output Impedance:

600 ohms.

Input Impedance: High I avai

,g.,,	100100111111111111111111111111111111111
Phono (except	
CD-4 mode)	47k ohms
CD-4 IIIOue/	4/K UIIII13
Phono (CD-4 mode)	100k ohma

Frequency Response:

High Level-20-20,000Hz	. ±0.2db
RIAA Phono-Equalization	. ±1db

Distortion:

Harmonic Distortion \leq 0.2%, 20-20,000 Hz at rated output.

IM Distortion < 0.2% at rated output.

Hum and Noise:

High Level	Minimum 80db below rated output. Noise
Phono	typically 90db down. 500 μ V A weighted

(Unweighted, typically less than 1 mV.)

Low Filter:

-3db@70Hz, 6db per octave attenuation.

High Filter:

-3db@7kHz, 12db per octave attenuation.

Tone Control Range:

Bass		
Treble		
Volume Muting.	 .	20db

POWER REQUIREMENTS

Voltage 105-130 Vac or 21	0-260 Vac
Frequency 50-60 H	z (ac only)
Maximum power consumption	30 watte

MECHANICAL

Dimensions:

6" high x 18" wide x 13 1/8" deep.

Weight:

100k ohme

12 pounds.

8/75 107143

SQ is a trademark of CBS Labs, Inc., and CD-4 is a trademark of JVC America, Inc.

SERVICE MANUAL

DISASSEMBLY PROCEDURE

I. Removing the Phono Board

- A. Remove the four screws holding the top cover in place.
- B. Locate the three interboard supports holding the phono board in place. Using needle-nose pliers, squeeze the locking pin of the interboard support and gently slide the board over the top of each support. It is suggested that the board be lifted to the point of just keeping the support from locking again. Do not attempt to remove the board until all three pins have been unlocked.
- C. Gently slide the phono preamp board up and off the interconnect points of J12 and J1 after releasing all three pins.

Special Note: When reassembling the phono preamp circuit to the upper board, be certain to align the pins of J1 first. Then, by rotating the preamp board sideways, easy alignment of the J12 pins can be accomplished, using the three interboard supports as guides for the reconnection of the printed circuit board.

II. CD-4 Four-Channel Decoding Board

After removing the top cover, locate the three interboard supports. Using needle-nose pliers, gently squeeze the locking pin of the interboard supports (as described in section IB) and slide the board up over the locking pins. (Do not attempt to remove the board until all three locking pins have been released.) Then gently pull the board towards the volume control side of the preamp, sliding the board away from the J201 connection pins.

III. Servicing the Top Board

- A. After removing the four screws holding the top cover in place, remove the top cover.
- B. If service of the section of the top board located under the phono preamp is required, see Section 1 above.
- C. If service of the other components of the top board is required, locate the section of the circuit by using the appropriate diagram.

IV. Access to the Lower Printed Circuit Board [Exposed Foil Section]

- A. Remove the seven screws holding the bottom cover in place.
- B. If service to the power transformer or ac switched and unswitched outlets is required, voltage conversion, or other similar service, remove the power supply shield by unscrewing the rear chassis screw holding the shield in place. (This is necessary for voltage conversion changes as well.)
- C. Access to all exposed components located on the lower board is now possible.

V. Access to Decoder Module

A. Access to the bottom board is obtained as indicated in Section IV. Repair of either module can be accomplished by simply removing the screws holding the module to the rear chassis bracket assembly and sliding the module off its respective pin assembly (J101 or J102).

VI. Service of Foil (Etch) of Upper or Lower Board

- A. Remove the seven screws holding the bottom cover in place.
- B. Remove the decoder module(s) plugged into the bottom board (at connection Points J101 or J102).
- C. Remove the top cover by removing the four screws holding it in place.
- D. Locate the stud coming from front panel (above the source push button) and remove the nut, lock-washer, and flat-washer.
- E. Remove the knobs (not the push buttons) from the front panel. Be certain, when removing the knobs, to maintain the order and location of these knobs as they have been matched to each control for proper appearance and operation. (If difficulty is experienced in removing the knob, try using either insulated wire or heavy twine wrapped around the knob.)
- F. Very carefully, remove the headphone locking nut found on the front panel. Extreme care should be taken to not scratch the front panel.
- G. Remove the four 1/2 inch locking nuts holding the front panel in place.
- H. Remove the two screws holding the lower pc board bracket assembly to the side chassis. These two screws are located near the front of the chassis on either side of the preamplifier.
- I. On the upper board, locate the six interconnect pin assemblies, J2, 3, 5, 6, 7, 8. (do not remove J4.) Remove these six interconnect pin assemblies connecting the upper board to the lower board by gently pulling the pin assembly upward until they are disengaged from the lower board. (Needle-nose pliers may be used to lift the interconnect pin assemblies away from the connector on the upper pc board. Do not remove the pins from the upper board.)
- J. Unlock the four interboard supports found near the rear edge of the lower pc board using needle-nose pliers. Do not attempt to raise the board off the supports, but rotate the board toward the front of the unit, releasing Connector J4 and the four interboard supports.
- K. With the preamp laying on its top with the volume control nearest the bench, lift the lower pc board out of the chassis assembly and lay it to your left. This completes major disassembly for service to the foil side of both printed-circuit boards.

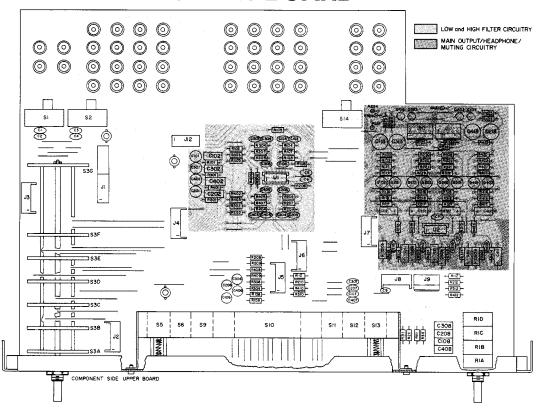
Special Note #1: Care should be taken when extending the power transformer and headphone cables so that no tension is placed on the cable assemblies. It is unnecessary to unplug the power transformer when servicing the unit.

Special Note #2: When reassembling the preamp, make certain that interconnect board locking pins are secure when repositioning the board assemblies. Also, J4 interboard can be reinserted using a flat-blade screwdriver.

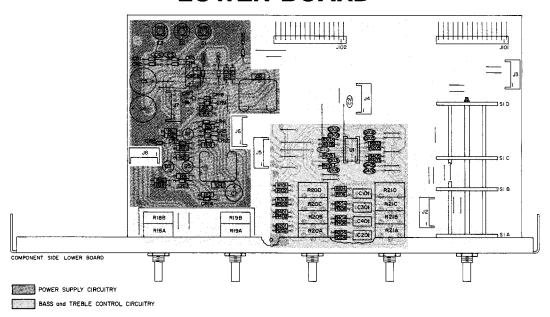
PARTS LIST

SYMBOL	DESCRIPTION	PART NUMBER	SYMBOL	DESCRIPTION	PART NUMBER
	CHASSIS & FRONT PANEL ASSEMBLY	<u>'</u>		UPPER PC BOARD (Cont'd	<u>.)</u>
	Capacitors			Capacitors	
	0.0047 µf, 1.4 kV Disc	103447	C1 2 3 4 10	05	
	Inductors		C1, 2, 3, 4, 1, 205, 305, 40; C9, 103, 104	5, 270 pf, 10%, 200 V, Disc	103727
T-1	Power Transformer	103883	C9, 103, 104 203, 204, 30 304, 403, 40	3, 4 0.001 μ f, 10%, 200 V, Disc	103729
	Miscellaneous		304, 403, 40 C5, 6, 7, 8 C102, 202,	0.01 µf, Disc	103730
	Front & Rear Headphone Plug-In Assy	104965	302, 402 C108, 208,	0.022 μt, 10%, 50 V, Mylar	103731
	Internal Headphone Washer Internal Headphone Hex Nut	103769 103033 103545	308, 408 C101, 201, 3	0.047 µf, 10%, 50 V, Mylar 301,	103732
	Front Panel Headphone Knurled Nut Pushbutton Sleeve Locking Interboard Support	103545 104547 103924-10	401,106,20 306,406	⁵ , 5 μf, Nonpolar, 15 V, Electrolytic	103737
	Pilot Light Socket	103924-10 103834 104870-18	C113, 213, 313, 413	15 μf, 25 V, Nonpolar, Electrolyti	c 103946
S-15	Locking Phono Board Support On/Off Switch Bracket On/Off Switch	104510 103847		Semiconductors	
0.0	Power Switch Screw Lamp #1847	103150-03 102580	U1, U2 Q101, 201,	Quad Op Amp, RC4136DP	103848
	Knob, Large Knob, Small	104327 104328	301, 401 Q102, 202,	2N3569	103850
	Knob, Inner Knob, Outer	104329 104330	302,402 Q103, 203,	2N3644	103851
	Knob, Pushbutton Left Side Panel	103877 103863	303, 403	N Channel FET, E111 Miscellaneous	104019
	Right Side Panel Side Panel Screws	103864 103122-05		Phone look PC Mounted	103832
	Top Cover Bottom Cover	103871 103872	J2, 3, 4, 5, 6, 7, 8 J9, 10, 11 J1(2), 2, 3, 4 5, 6, 7, 8, 12 U1, U2	6-Circuit PC Connector, Top Inse	ert 103838
F 4	Bottom & Top Cover Screws Jewel, Pilot Light	103122-05 103460	J9, 10, 11 J1(2), 2, 3, 4	5-Circuit Interconnect Pin 4,	103839
F-1	Fuse 1/2A, Slow Blo 250 V Rubber Foot Rubber Foot Screw	104714-050 103887	0, 6, 7, 8, 12 U1, U2	2 6-Circuit Interconnect Pin IC Terminal Strip	103841 103922 103923
	Chassis Ground Post Remote Balance Receptacle	103122-08 103862 103844	U1, U2 S5, 6, 9, 10 11, 12, 13		103923
	Fuse Holder Accessory Outlet	102707 103830	\$3 \$1, 2, 14	Source Switch Phono Capacitance/ Equalizer By	103738
	Headphone Jack	104570		Phono Locking Support	104870-18
	PHONO BOARD			LOWER PC BOARD Resistors	
	Resistors		R3 R5		102942-620 102942-751
R104, 304 R2	1/2 W, Comp, 360, 5% Low Noise 1/4 W, Film, 10.0 K, 1% 1/4 W, Film, 28.7 K, 1% 1/4 W, Film, 365 K, 1% 1/4 W, Film, 4.99 K, 1%	102943-361 104095-1002	R18	1/2 W, Comp, 62, 5% 1/2 W, Comp, 750, 5% Pot, Front/Back Balance Contro	102942-751 I 103741
R102, 302 R103, 303	1/4 W, Film, 28.7 K, 1% 1/4 W, Film, 365 K, 1%	104095-2872 104095-3653	R19 R20, 21	Pot, Left/Right Balance Control Pot, 4-Section Tone Control	103742 103907
R1		104095-4991		Capacitors	
	Capacitors		C8, 9 C103, 203,	5 μ f, 25 V, Electrolytic	100260-1
C108, 308 C1, 2, 106, 306 C103, 105, 303	0.01 μf Disc 5 μf, 25 V, Electrolytic	103730 103735	303, 403 C102, 202, 302,402 C1, 2, 3, 4 C5, 6	22 pf, 20%, 200 V, Disc	103725
305 C101, 301	' 0.0027 μf, 5%, 50 V, Mylar 1 μf, 25 V, Electrolytic	103914 104015	302,402 C1, 2, 3, 4	220 pf, 10%, 200 V, Disc 0.01 µf, Disc	103728 103730
C3 C102, 107, 302	47 µf, 50 V, Electrolytic	104016	[CIUI, 201,	1000 µf, 35 V, Electrolytic	103736
307 C104, 304	['] 130 pf , 300 V , 10% , Disc 0.0091 μ f , 5% , 50 V , Mylar 0.47 μ f , 25 V , Electrolytic	104017 104018	301 , 401 C7	0.068 µf, 5%, 50 V, Mylar 47 µf, 50, V Electrolytic	103948 104016
C109, 309	0.47 μf, 25 V, Electrolytic	104817		Semiconductors	
0404 :00	Semiconductors		Q2 CR1, 2, 3, 4	PNP PWR TIP-30	102016-1
Q101, 103, 301, 303	Transistor, NPN, Low Noise, BC239C	102437-2	15, 16 U1	1 N4002	102020-1 103848
Q102, 104, 302, 304 Q105, 305	2N5086 N Channel FET, E111	103925 104019	I ∩4	Quad Op Amp, RC4136DP NPN PWR TIP-29 2N3644	103849 103851
Q100, 300	Miscellaneous	104019	01, 3, 5 CR5, 6, 7, 9 10, 11, 12,	9, 13,	
J1 (2), 12	6-Circuit PC Connector, Bottom Insert	103837	14, 18 CR8, 17	Diode 1N4148 Diode, Zener, 15 V	102410 103763
J201	Right-Angle Connector, 15-Circuit	103842		Miscellaneous	
	UPPER PC BOARD		12 2 4 5	Heat Sink	103859
	Resistors		J2, 3, 4, 5, 7, 8 J101, 102	6-Circuit PC Connector, Bottom Right-Angle Connector, 15-Circu	Insert 103837 uit 103842
R1	Potentiometer, 4-Section Volume Control	ol 103740	U1 U1 U1	IC Terminal Strip Nylon IC Nest	103922
	,		ši	Mode Switch Locking Interboard Support	103923 103815 103924-10
	Capacitors			COMPLETE ASSEMBLIES	
C109, 111, 209, 211, 309, 311, 409, 411, 112, 212, 312, 412 C110, 210, 310, 410 C107, 207, 307, 407,			Phono Boa		103662
409, 411, 112, 212, 312, 412	5 μf, 25 V, Electrolytic	100260-1	Front Pane Upper Boa	el Assy	103654 103660
C110, 210, 310, 410_	22 pf, 10%, 200 V, Disc	103725	Lower Boa	rd Assy	103661
C107, 207, 307, 407,	220 pf, 10%, 200 V, Disc	103726	Carton Ass Owner's M		104723 1042 9 6
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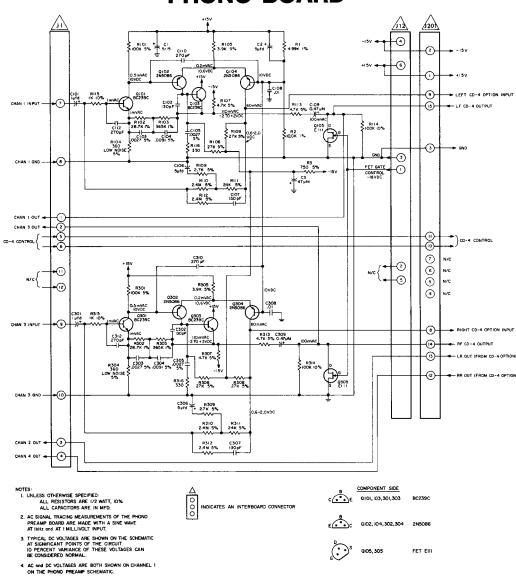
UPPER BOARD

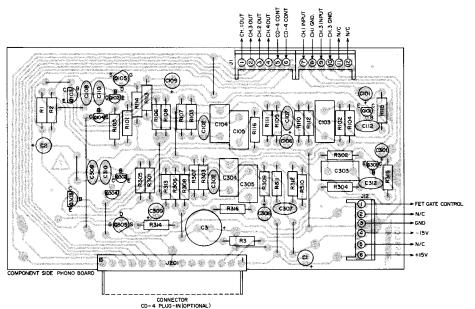


LOWER BOARD

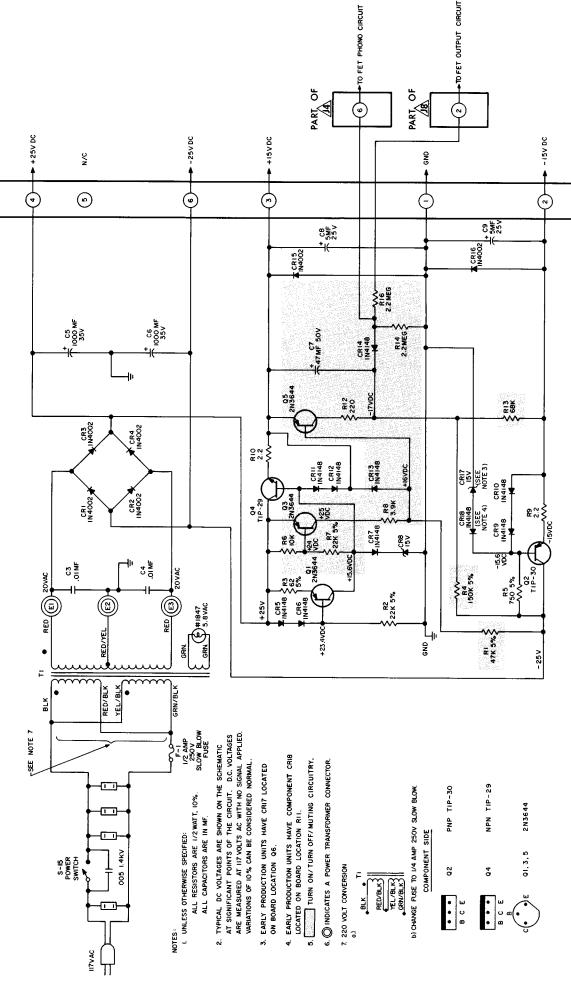


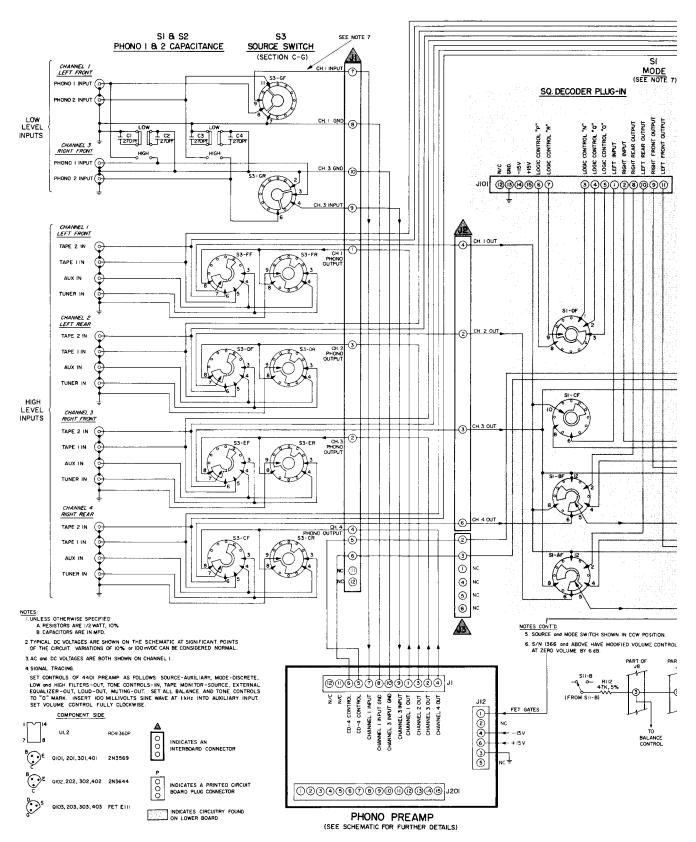
PHONO BOARD



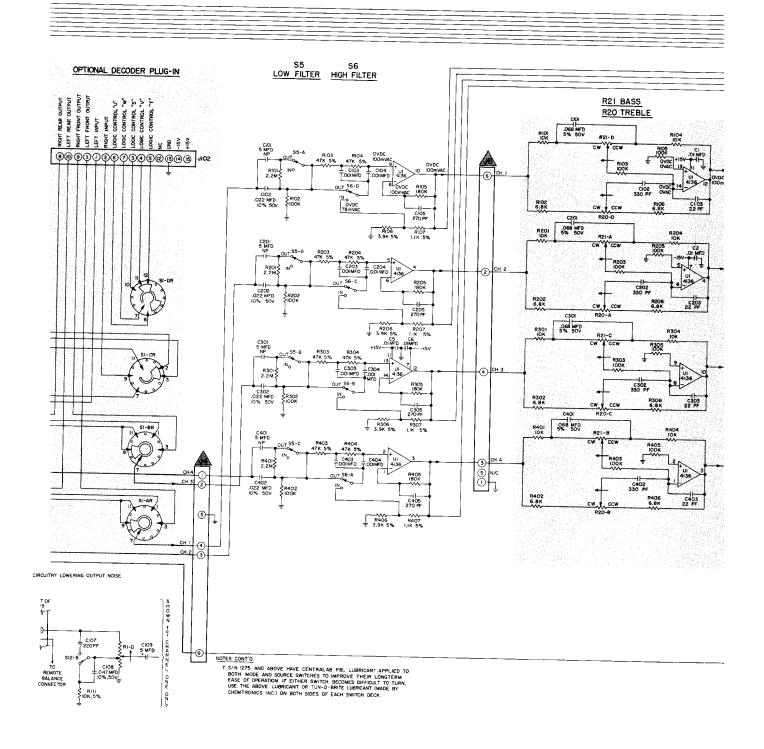


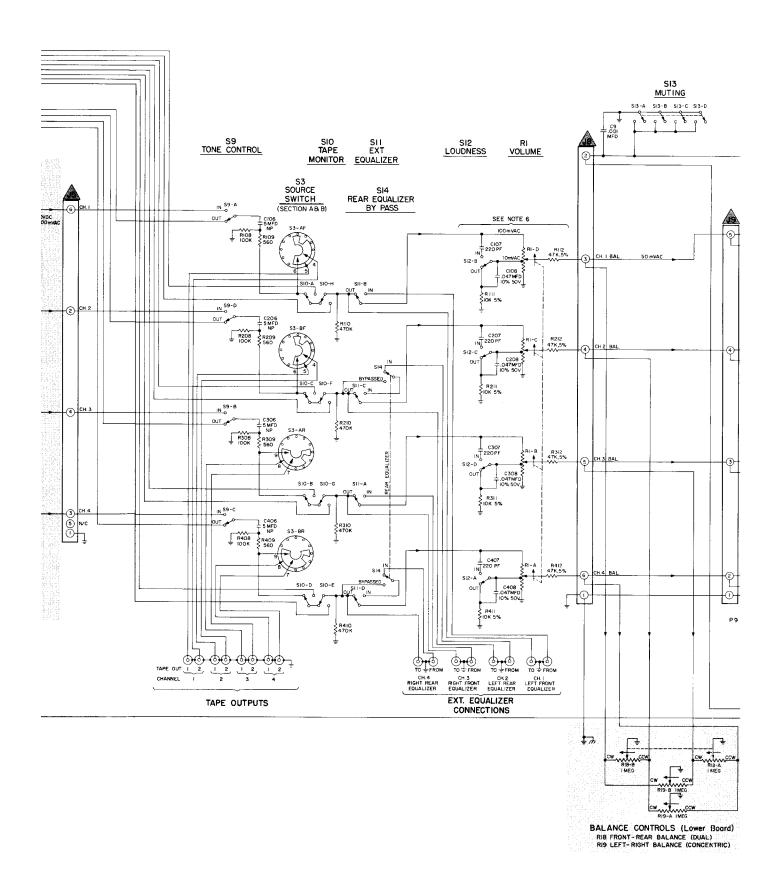
POWER SUPPLY

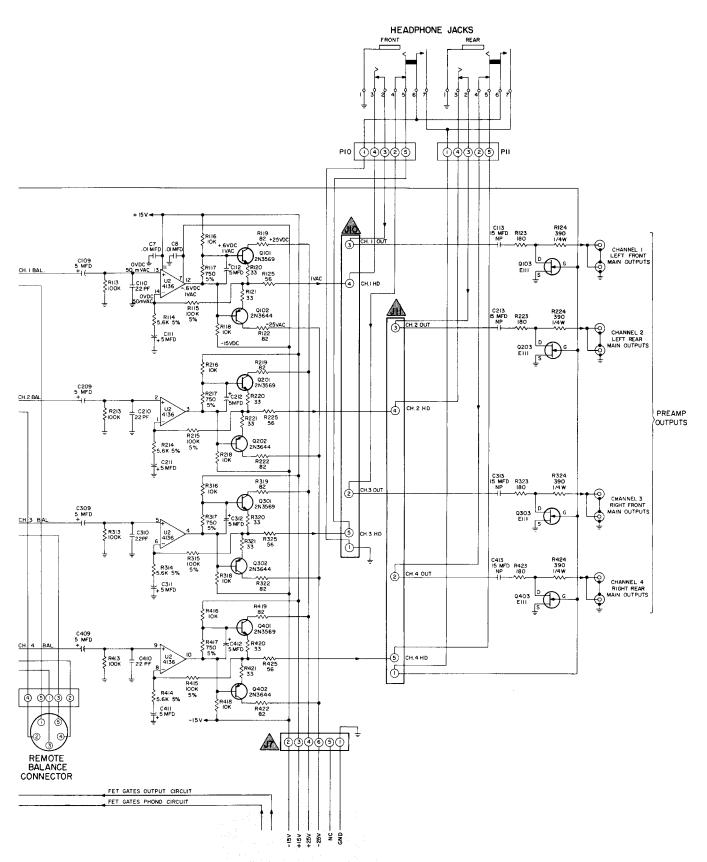




CONSUMERS CONCERNED WITH HIGH ZERO VOLUME NOISE SHOULD FIRST BE REQUESTED TO ADJUST THEIR HIGH FIDELITY SYSTEM FOR OPTIMUM SYSTEM MOISE PERFORMANCE START BY SETTING THE 4401 VOLUME CONTROL AT FOUL AND THE POWER AMP GAIN CONTROL AT FULL VOLUME. IF NOISE IS HEARD IN THE SPEAKERS, REDUCE THE POWER AMP GAIN CONTROL UNTIL THE NOISE JUST BECOMES INAUDIBLE ALTERNATIVELY, UNITS CAN BE RETURNED TO BOSE FOR THE WARRANTY MODIFICATION, SHOWN ON THE ABOVE SCHEMATIC.







POWER SUPPLY (Lower Board)
(SEE SCHEMATIC FOR FURTHER DETAILS)